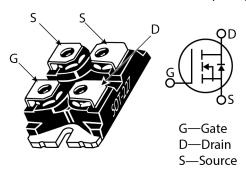
MSC080SMA120J

Silicon Carbide N-Channel Power MOSFET

Product Overview

The silicon carbide (SiC) power MOSFET product line from Microsemi increases the performance over silicon MOSFET and silicon IGBT solutions while lowering the total cost of ownership for high-voltage applications. The MSC080SMA120J device is a 1200 V, 80 m Ω SiC MOSFET in an SOT-227 package.



Features

The following are key features of the MSC080SMA120J device:

- Low capacitances and low gate charge
- · Fast switching speed due to low internal gate resistance (ESR)
- Stable operation at high junction temperature, T_{J(max)} = 175 °C
- · Fast and reliable body diode
- Superior avalanche ruggedness
- RoHS compliant
- · Isolated voltage to 2500 V

Benefits

The following are benefits of the MSC080SMA120J device:

- · High efficiency to enable lighter, more compact system
- · Simple to drive and easy to parallel
- · Improved thermal capabilities and lower switching losses
- Eliminates the need for external freewheeling diode
- Lower system cost of ownership

Applications

The MSC080SMA120J device is designed for the following applications:

- · PV inverter, converter, and industrial motor drives
- · Smart grid transmission and distribution
- Induction heating and welding
- H/EV powertrain and EV charger
- · Power supply and distribution

1. Device Specifications

This section shows the specifications of the MSC080SMA120J device.

1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of the MSC080SMA120J device.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain source voltage	1200	V
I _D	Continuous drain current at T _C = 25 °C	31	А
	Continuous drain current at T _C = 100 °C	22	
I _{DM}	Pulsed drain current ¹	77	
V _{GS}	Gate-source voltage	23 to -10	V
P _D	Total power dissipation at T _C = 25 °C	143	W
	Linear derating factor	0.95	W/°C

Note:

1. Repetitive rating: pulse width and case temperature limited by maximum junction temperature.

The following table shows the thermal and mechanical characteristics of the MSC080SMA120J device.

Table 1-2. Thermal and Mechanical Characteristics

Symbol	Characteristic/Test Conditions	Min	Тур	Max	Unit
$R_{\theta JC}$	Junction-to-case thermal resistance		0.70	1.05	°C/W
T _J	Operating junction temperature	-55		175	°C
T _{STG}	Storage temperature	-55		150	
T _L	Soldering temperature for 10 seconds (1.6 mm from case)			300	
V _{ISOLATION}	RMS voltage (50 Hz–60 Hz sinusoidal waveform from terminals to mounting base for 1 minute)	2500			V
	Mounting torque, M4 screw			10	lbf-in
				1.1	N-m
Wt	Package weight		1.03		oz
			29.2		g

1.2 Electrical Performance

The following table shows the static characteristics of the MSC080SMA120J device. $T_J = 25$ °C unless otherwise specified.

Table 1-3. Static Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 100 \mu\text{A}$	1200			V
R _{DS(on)}	Drain-source on resistance ¹	$V_{GS} = 20 \text{ V}, I_D = 15 \text{ A}$		80	100	mΩ
V _{GS(th)}	Gate-source threshold voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	1.9	2.8		V
$\Delta V_{GS(th)}/\Delta T_J$	Threshold voltage coefficient	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$		-4.5		mV/°C
I _{DSS}	Zero gate voltage drain current	V _{DS} = 1200 V, V _{GS} = 0 V			100	μΑ
	urain current	V _{DS} = 1200 V, T _J = 125 °C, V _{GS} = 0 V			500	
I _{GSS}	Gate-source leakage current	V _{GS} = 20 V/–10 V			±100	nA

Note:

1. Pulse test: pulse width < 380 μ s, duty cycle < 2%.

The following table shows the dynamic characteristics of the MSC080SMA120J device. T_J = 25 °C unless otherwise specified.

Table 1-4. Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
C _{iss}	Input capacitance	V _{GS} = 0 V, V _{DD} = 1000 V		838		pF
C _{rss}	Reverse transfer capacitance	$V_{AC} = 25 \text{ mV}, f = 1 \text{ MHz}$		9		
C _{oss}	Output capacitance			84		
Q_g	Total gate charge	$V_{GS} = -5 \text{ V}/20 \text{ V}, V_{DD} = 800 \text{ V}$		64		nC
Q_{gs}	Gate-source charge	I _D = 15 A		12		
Q_{gd}	Gate-drain charge			19		

con	tinued					
Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit
t _{d(on)}	Turn-on delay time	V_{DD} = 850 V, V_{GS} = -5 V/20 V I_{D} = 20 A, $R_{g(ext)}$ = 4 Ω		14		ns
t _r	Voltage rise time	Freewheeling diode =		14		
t _{d(off)}	Turn-off delay time	MSC080SMA120J ($V_{GS} = -5V$) (reference Fig. 1-17)		19		
t _f	Voltage fall time			13		
E _{on}	Turn-on switching energy			350		μJ
E _{off}	Turn-off switching energy			65		
ESR	Equivalent series resistance	f = 1 MHz, 25 mV, drain short		1.9		Ω
SCWT	Short circuit withstand time	V _{DS} = 960 V, V _{GS} = 20 V		3		μS
E _{AS}	Avalanche energy, single pulse	V _{DS} = 150 V, I _D = 15 A		1000		mJ

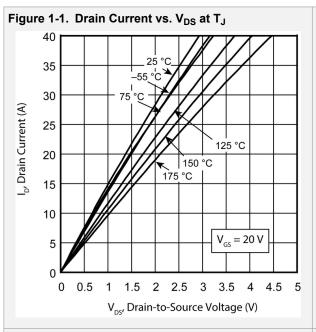
The following table shows the body diode characteristics of the MSC080SMA120J device. T_J = 25 °C unless otherwise specified.

Table 1-5. Body Diode Characteristics

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V_{SD}	Diode forward voltage	I _{SD} = 15 A, V _{GS} = 0 V		4.0		V
		$I_{SD} = 15 \text{ A}, V_{GS} = -5 \text{ V}$		4.2		
t _{rr}	Reverse recovery time	$I_{SD} = 15 \text{ A}, V_{GS} = -5 \text{ V}$		34		ns
Q _{rr}	Reverse recovery charge	$V_{DD} = 800 \text{ V}, \text{ dI/dt} = -1000 \text{ A/}\mu\text{s}$		200		nC
I _{RRM}	Reverse recovery current			6.5		Α

1.3 Typical Performance Curves

This section shows the typical performance curves of the MSC080SMA120J device.



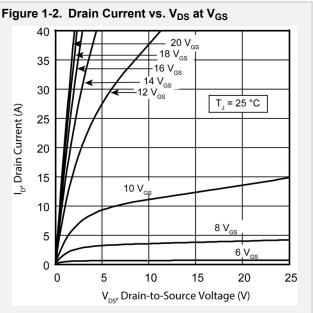


Figure 1-3. Drain Current vs. V_{DS} at V_{GS}

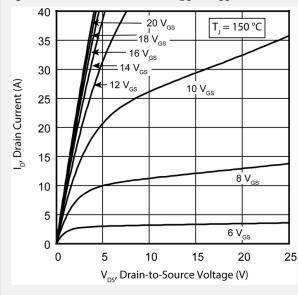
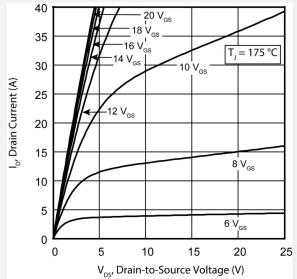
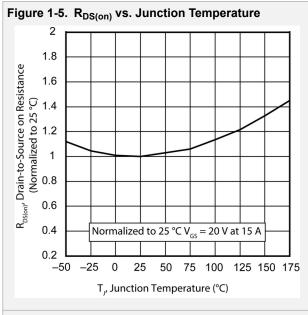


Figure 1-4. Drain Current vs. V_{DS} at V_{GS}





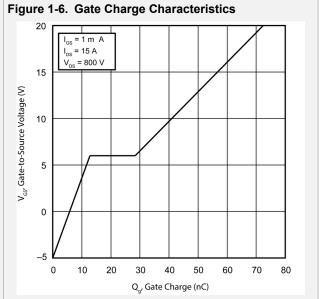
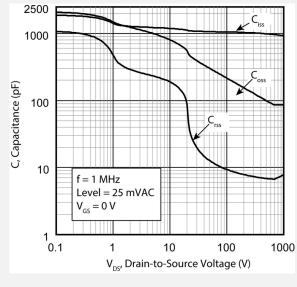
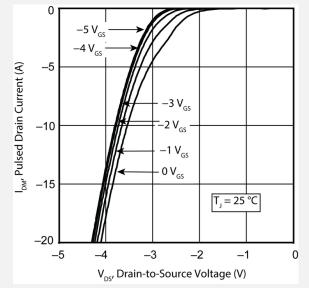
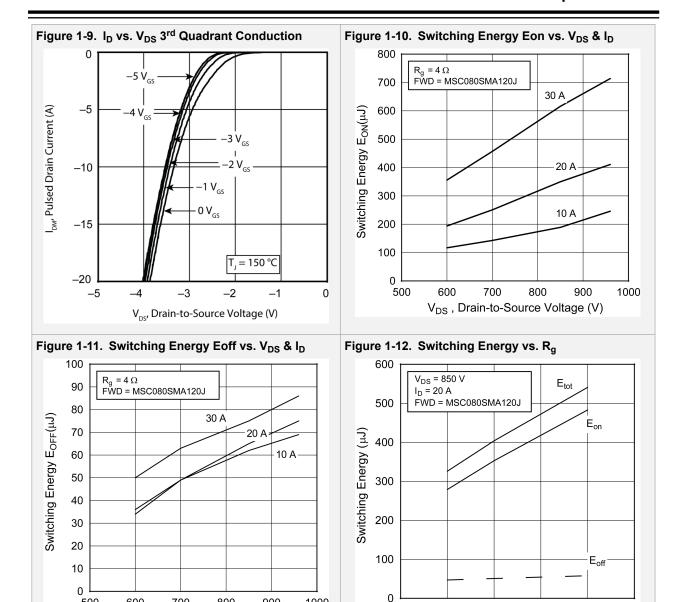


Figure 1-7. Capacitance vs. Drain-to-Source Voltage | Figure 1-8. I_D vs. V_{DS} 3rd Quadrant Conduction







1000

0

2

4

 $R_g(\Omega)$

6

8

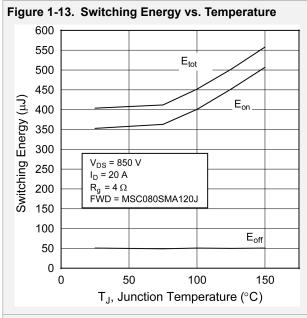
10

500

700

800

 V_{DS} , Drain-to-Source Voltage (V)



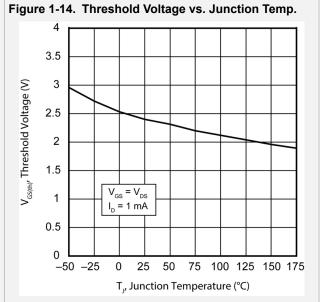
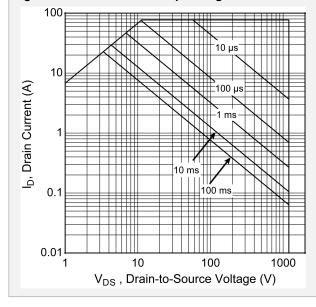
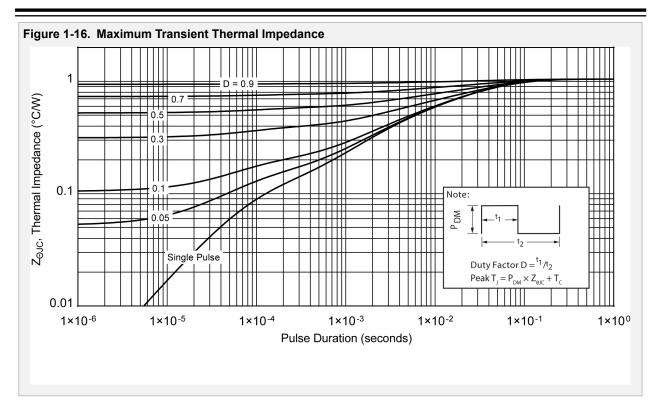


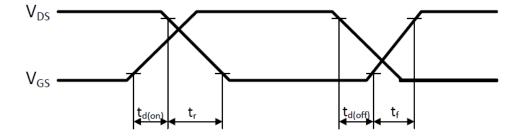
Figure 1-15. Forward Safe Operating Area





The following figure shows the switching waveform diagram of the MSC080SMA120J device.

Figure 1-17. Switching Waveform



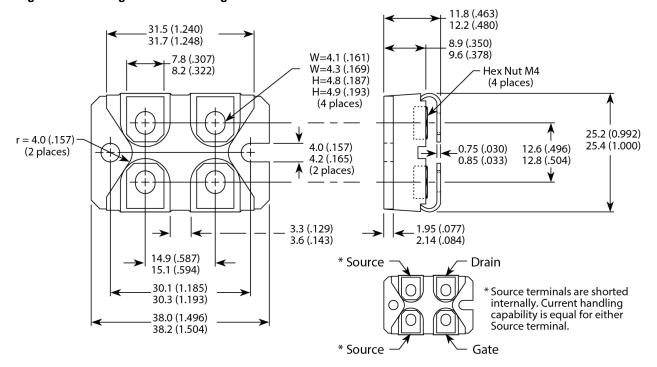
2. Package Specification

This section shows the package specification of the MSC080SMA120J device.

2.1 Package Outline Drawing

The following figure illustrates the SOT-227 package outline of the MSC080SMA120J device. The dimensions in the figure below are in millimeters and (inches).

Figure 2-1. Package Outline Drawing



3. Revision History

Table 3-1. Revision History

Revision	Date	Description
A	06/2021	Document migrated from Microsemi template to Microchip template; Assigned Microchip literature number DS-00004138A,which replaces the previous Microsemi literature number 050-7767.
Initial release (Microsemi Revision A)	02/2020	Document created.

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